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SAW Components

BAW Bluetooth/WLAN Filter

Datasheet

Series/type: B8831

Ordering code: B39242B8831P810

Date: August 18, 2014

Version: 2.0

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SAW Components

B8831

BAW Bluetooth/WLAN Filter

2442.0 MHz

Datasheet



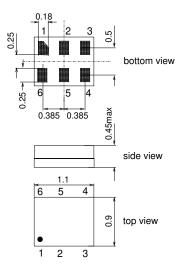
Application

- Low-loss BAW RF single filter for Bluetooth/WLAN with LTE Band 7 / Band 40 / Band 41 coexistence
- Usable passband 79.0 MHz
- Unbalanced to unbalanced operation
- Excellent insertion loss
- High out of band selectivity
- \blacksquare Filter impedance 50 Ω



Features

- Package size 1.1 x 0.9 x 0.4 mm³
- RoHS compatible
- Approximate weight 0.0012 g
- Package for Surface Mount Technology (SMT)
- Ni, gold-plated terminals
- Electrostatic Sensitive Device (ESD)
- Moisture Sensitivity Level 3 (MSL 3)



Pin configuration

1 Input (unbalanced)4 Output (unbalanced)

■ 2,3,5,6 To be grounded



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Characteristics of Filter

 $T = -30 \,^{\circ}\text{C} \text{ to } +85 \,^{\circ}\text{C}$ Temperature range for specification:

 $Z_S = 50 \Omega$ shunt coil 6.8 nH $Z_L = 50 \Omega$ shunt coil 6.8 nH Terminating source impedance: Terminating load impedance:

| | B8831 | | | |
|---|-------------------------|---------|------|-----|
| Characteristics | min. | typ. | max. | |
| | | @ 25 °C | | |
| Center frequency f _C | _ | 2442.0 | _ | MHz |
| Maximum insertion attenuation - WLAN¹) α_{max} | | | | |
| 2403.1 2420.9 MHz (channel 1) 1) | _ | 1.35 | 2.1 | dB |
| 2408.1 2425.9 MHz (channel 2) 1) | _ | 1.2 | 1.8 | dB |
| 2413.1 2465.9 MHz (channel 3-10) 1) | _ | 1.1 | 1.7 | dB |
| 2453.1 2470.9 MHz (channel 11) 1) | _ | 1.1 | 1.9 | dB |
| 2458.1 2475.9 MHz (channel 12) 1) | _ | 1.3 | 2.2 | dB |
| 2463.1 2480.9 MHz (channel 13) 1) | _ | 1.65 | 2.9 | dB |
| VSWR (Input and Output) | | | | |
| 2403.1 2475.9 MHz (channel 1-12) | _ | 1.8 | 2.4 | |
| 2463.1 2480.9 MHz (channel 13) | | 1.8 | _ | |
| Attenuation α | | | | |
| 100.0 1805.0 MHz | 34 | 36 | _ | dB |
| 1805.0 2170.0 MHz | 35 | 37 | _ | dB |
| 2300.0 2360.0 MHz ²⁾ | 34 | 38 | _ | dB |
| 2360.0 2365.0 MHz ²⁾ | 38 | 45 | _ | dB |
| 2365.0 2370.0 MHz ²⁾ | 40 | 47 | _ | dB |
| 2496.0 2501.0 MHz ²⁾ | 17 ³⁾ | 43 | _ | dB |
| 2500.0 2505.0 MHz ²⁾ | 43 ³⁾ | 60 | | dB |
| 2505.0 2550.0 MHz ²⁾ | 50 | 57 | _ | dB |
| 2550.0 2570.0 MHz ²⁾ | 47 | 50 | _ | dB |
| 2570.0 2620.0 MHz ²⁾ | 44 | 48 | _ | dB |
| 2620.0 2690.0 MHz ²⁾ | 44 | 47 | _ | dB |
| 4800.0 5805.0 MHz | 20 | 27 | _ | dB |
| 7200.0 7500.0 MHz | 20 | 28 | _ | dB |
| 2nd Harmonics | | | | |
| CW tone at input, 2442 MHz, 22 dBm | | -63 | | dBc |

Averaged values within each WiFi channel width of 17.8 MHz
 Averaged value of linear S-parameter over 5 MHz

^{3) +25°}C to +85°C



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Maximum ratings

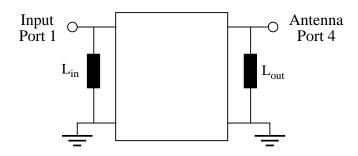
| Operable temperature range | Т | -30/+85 | °C | |
|----------------------------|------------------|-------------------|-----|---------------------------|
| Storage temperature range | T _{stg} | -40/+90 | °C | |
| DC voltage | V _{DC} | 5 ¹⁾ | V | |
| ESD voltage | V _{ESD} | 50 ²⁾ | V | Machine Model |
| | | 300 ³⁾ | V | Human Body Model |
| | | 600 ⁴⁾ | V | Charged Device Model |
| Input power at PIN1 | | 26 | dBm | 20 MHz OFDM signal, 65°C, |
| channel 1 to channel 13 | | | | 5000 hr |

^{1) 168}h Damp Heat Steady State acc. to IEC60068-2-67 Cy

Matching network

- $L_{in} = 6.8 \text{ nH}$
- $L_{out} = 6.8 \text{ nH}$

Recommendation to use TDK MLG0603 P-series



²⁾ acc. to JESD22-A115B (MM - Machine Model), 10 negative & 10 positive pulses

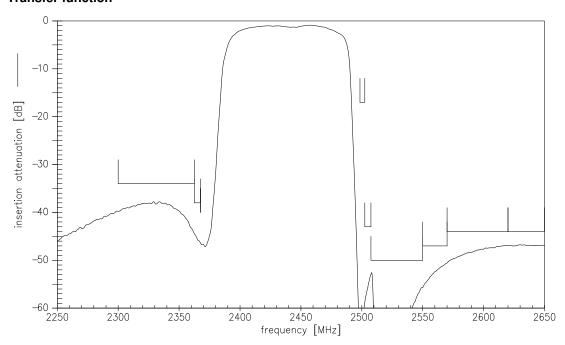
³⁾ acc. to JESD22-A114F (HBM - Human Body Model), 1 negative & 1 positive pulses

⁴⁾ acc. to JESD22-C101C (CDM - Field Induced Charged Device Model), 3 negative & 3 positive pulses

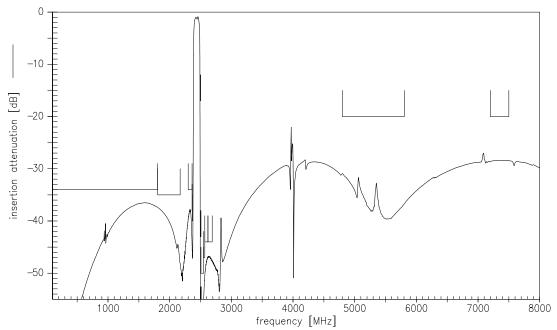


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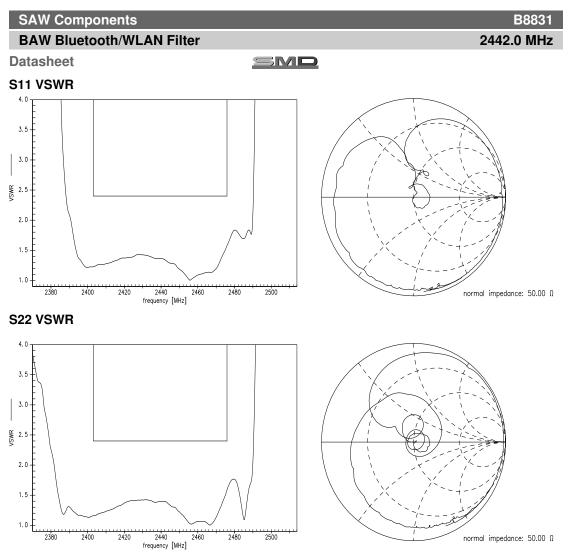
Transfer function



Transfer function









SAW Components B8831 BAW Bluetooth/WLAN Filter 2442.0 MHz

Datasheet



References

| Туре | B8831 |
|---------------------|--|
| Ordering code | B39242B8831P810 |
| Marking and package | C61157-A8-A162 |
| Packaging | F61074-V8255-Z000 |
| Date codes | L_1126 |
| S-parameters | B8831_HD_WB_UN.s2p See file header for port/pin assignment table. |
| Soldering profile | S_6001 |
| RoHS compatible | RoHS-compatible means that products are compatible with the requirements according to Art. 4 (substance restrictions) of Directive 2011/65/EU of the European Parliament and of the Council of June 8th, 2011, on the restriction of the use of certain hazardous substances in electrical and electronic equipment ("Directive") with due regard to the application of exemptions as per Annex III of the Directive in certain cases. |
| Moldability | Before using in overmolding environment, please contact your EPCOS sales office. |
| Matching coils | See Inductor pdf-catalog http://www.tdk.co.jp/tefe02/coil.htm#aname1 and Data Library for circuit simulation http://www.tdk.co.jp/etvcl/index.htm |

For further information please contact your local EPCOS sales office or visit our webpage at $\underline{www.epcos.com}$.

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